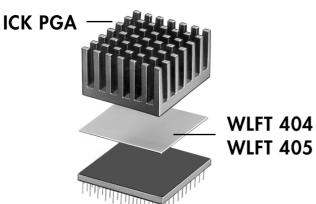
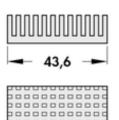
23.11.10 08:26 Details

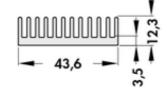
## Heatsinks for PGA / ICK PGA 17 x 17 x 12



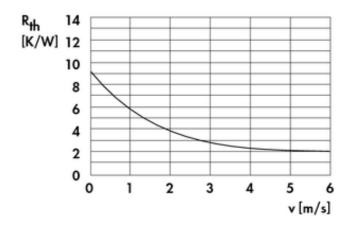


00000000000 0000000000

000000000000



therm. conductive foil / therm. cond. adhesive



 $43,6 \times 43,6 \times 12,3$  mm, for IC design PGA and others

## Parameters of article ICK PGA 17 x 17 x 12

R<sub>th</sub> [K/W]

**(1)** 9

dissipation loss [W] mounting method

**(1)** 6.5

socket universal suitable for processor type universal width [mm] 43.6

heigth [mm] 12.3 plate thickness [mm] 3.5 length on stock [mm] 43.6

surface treatment black anodised

## Accessories/ related articles

Thermally conductive foil both sides adhesive / WLFT 404 43 x 43

Thermally conductive foil both sides adhesive / WLFT 405 43 x 43

## **X-ON Electronics**

Largest Supplier of Electrical and Electronic Components

Click to view similar products for fisher manufacturer:

Other Similar products are found below:

FR 105 52 220 ME FR 120 42 200 ME GEL 28 30 GEL 45 10 GEL 45 50 GEL 60 10 AKG 33 20 80 ME BL 2 72 Z ICKSR40X30 LA 17 150 230 LA 21 150 230 LA 21 150 24 LA 27 K 100 12 LA 27 K 100 24 LA 27 K 150 12 LA 27 K 50 24 SK4615AL SK 47 250 SA SK56920AL SK57225SA SK57720AL SK58420AL SK58437.5SA SK 622 1000 AL SK 622 1000 SA SK 622 100 AL SK 623 100 SA SK 626 1000 SA SK 626 50 SA SK 627 1000 AL SK 627 200 AL SK 627 200 SA SK 627 50 SA SK 632 100 AL SK 633 25 AL SK 636 100 AL SK LED R 65 SA SK LED R 80 SA AKG 69 24 100 SA FR 80 42 160 ME GE K 80 42 100 SA GEL 45 30 GEL 60 25 GEL F 15 10 TUF 120 42 220 ME TUF 55 16 200 SA BL 3 36 Z LA 27 K 50 12 LA 27 K 75 24 WAG 200 SA